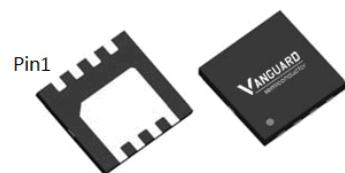


Features

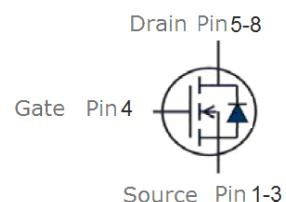
- N-Channel
- Enhancement mode
- Very low on-resistance $R_{DS(on)}$ @ $V_{GS}=4.5$ V
- Fast Switching
- 100% Avalanche Tested
- Pb-free lead plating; RoHS compliant

V_{DS}	30	V
$R_{DS(on),TYP}$ @ $V_{GS}=10$ V	9	$m\Omega$
$R_{DS(on),TYP}$ @ $V_{GS}=4.5$ V	12	$m\Omega$
I_D	38	A

TDFN3.3x3.3



Part ID	Package Type	Marking	Tape and reel information
VSB012N03MS	TDFN3.3x3.3	012N03M	5000pcs/Reel



Maximum ratings, at $T_j=25$ °C, unless otherwise specified

Symbol	Parameter	Rating	Unit
$V_{(BR)DSS}$	Drain-Source breakdown voltage	30	V
I_s	Diode continuous forward current	$T_c=25^\circ C$	A
I_D	Continuous drain current@ $V_{GS}=10$ V	$T_c=25^\circ C$	A
		$T_A=100^\circ C$	A
I_{DM}	Pulse drain current tested ①	$T_c=25^\circ C$	A
EAS	Avalanche energy, single pulsed ②	$I_D=20$ A	mJ
IAS	Avalanche energy, single pulsed ②	30	A
P_D	Maximum power dissipation	$T_A=25^\circ C$	W
V_{GS}	Gate-Source voltage	± 20	V
$T_{STG} T_J$	Storage and operating temperature range	-55 to 150	°C

Thermal Characteristics

Symbol	Parameter	Typical	Unit
$R_{\theta JC}$	Thermal Resistance-Junction to Case	3	°C/W
$R_{\theta JA}$	Thermal Resistance Junction-Ambient	45	°C/W

Typical Characteristics

Symbol	Parameter	Condition	Min.	Typ.	Max.	Unit
Static Electrical Characteristics @ T_c = 25°C (unless otherwise stated)						
$V_{(BR)DSS}$	Drain-Source Breakdown Voltage	$V_{GS}=0V, I_D=250\mu A$	30	--	--	V
I_{DSS}	Zero Gate Voltage Drain Current($T_c=25^\circ C$)	$V_{DS}=24V, V_{GS}=0V$	--	--	1	μA
	Zero Gate Voltage Drain Current($T_c=125^\circ C$)	$V_{DS}=24V, V_{GS}=0V$	--	--	100	μA
I_{GSS}	Gate-Body Leakage Current	$V_{GS}=\pm 20V, V_{DS}=0V$	--	--	± 100	nA
$V_{GS(TH)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D=250\mu A$	0.8	1.5	2.2	V
$R_{DS(ON)}$	Drain-Source On-State Resistance ^③	$V_{GS}=10V, I_D=25A$	--	9	12	mΩ
$R_{DS(ON)}$	Drain-Source On-State Resistance ^③	$V_{GS}=4.5V, I_D=10A$	--	12	16	mΩ
Dynamic Electrical Characteristics @ T_c = 25°C (unless otherwise stated)						
C_{iss}	Input Capacitance	$V_{DS}=15V, V_{GS}=0V, f=1MHz$	--	980	--	pF
C_{oss}	Output Capacitance		--	160	--	pF
C_{rss}	Reverse Transfer Capacitance		--	115	--	pF
Q_g	Total Gate Charge	$V_{DS}=15V, I_D=20A, V_{GS}=10V$	--	18	--	nC
Q_{gs}	Gate-Source Charge		--	4.5	--	nC
Q_{gd}	Gate-Drain Charge		--	5.5	--	nC
Switching Characteristics						
$t_{d(on)}$	Turn-on Delay Time	$V_{DD}=15V, I_D=10A, R_G=6.8\Omega, V_{GS}=10V$	--	7	--	nS
t_r	Turn-on Rise Time		--	14	--	nS
$t_{d(off)}$	Turn-Off Delay Time		--	22	--	nS
t_f	Turn-Off Fall Time		--	8	--	nS
Source- Drain Diode Characteristics@ T_c = 25°C (unless otherwise stated)						
V_{SD}	Forward on voltage	$I_{SD}=2A, V_{GS}=0V$	--	0.74	1.2	V
t_{rr}	Reverse Recovery Time	$T_j=25^\circ C, I_{SD}=10A, V_{GS}=0V, di/dt=100A/\mu s$	--	21	--	nS
Q_{rr}	Reverse Recovery Charge		--	11	--	nC

NOTE:

- ① Repetitive rating; pulse width limited by max. junction temperature.
- ② Limited by T_{Jmax} , starting $T_j = 25^\circ C$, $L = 0.3mH$, $R_G = 25\Omega$, $I_{AS} = 18A$, $V_{GS} = 10V$. Part not recommended for use above this value
- ③ Pulse width $\leq 300\mu s$; duty cycle $\leq 2\%$.

Typical Characteristics

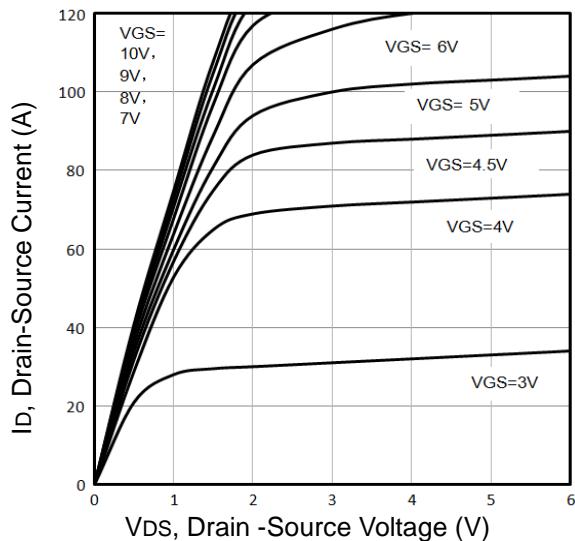


Fig1. Typical Output Characteristics

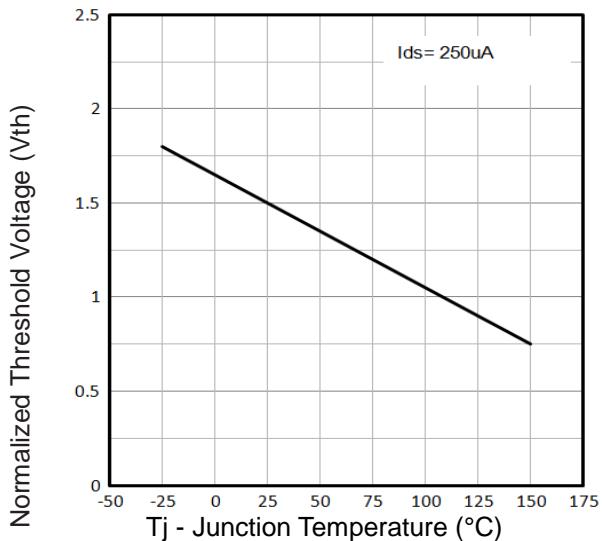


Fig2. Normalized Threshold Voltage Vs. Temperature

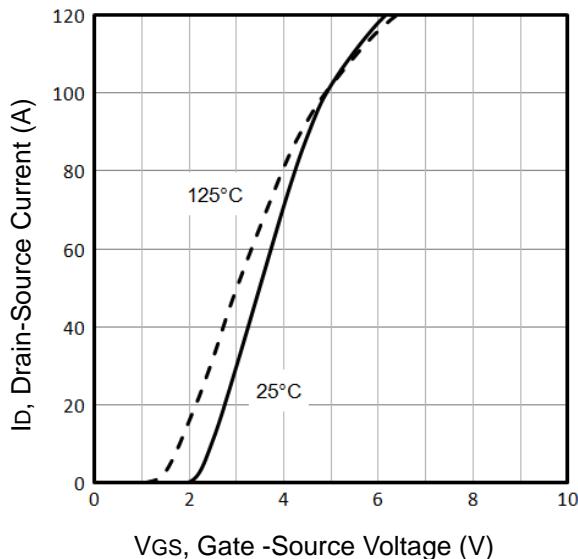


Fig3. Typical Transfer Characteristics

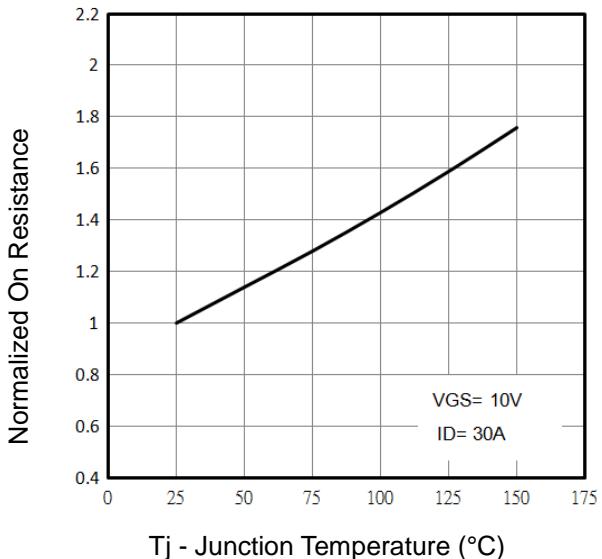


Fig4. Normalized On-Resistance Vs. Temperature

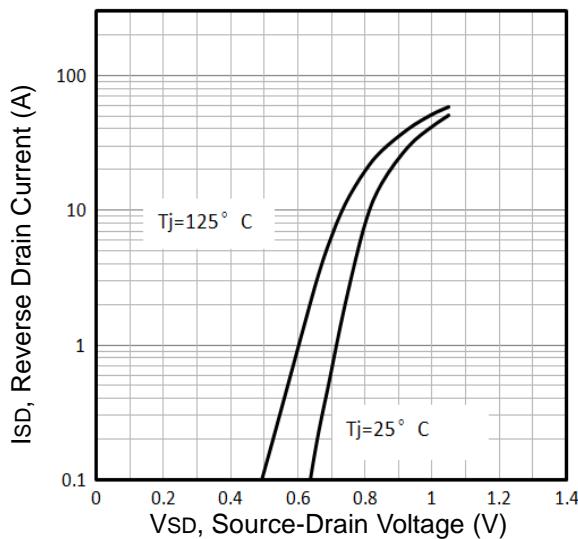


Fig5. Typical Source-Drain Diode Forward Voltage

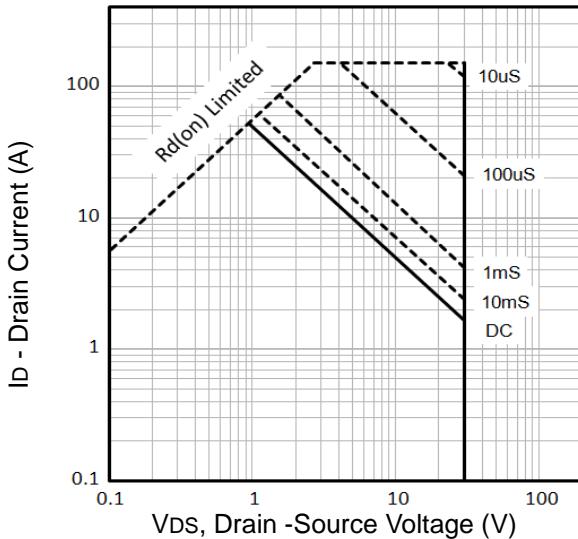


Fig6. Maximum Safe Operating Area

Typical Characteristics

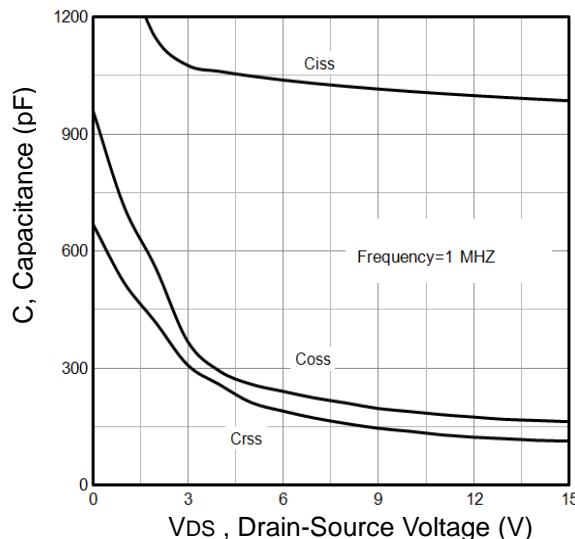


Fig 7. Typical Capacitance Vs.Drain-Source Voltage

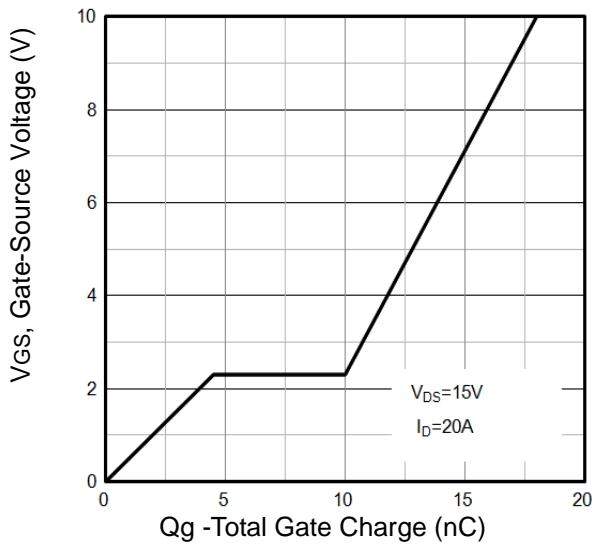


Fig 8. Typical Gate Charge Vs.Gate-Source

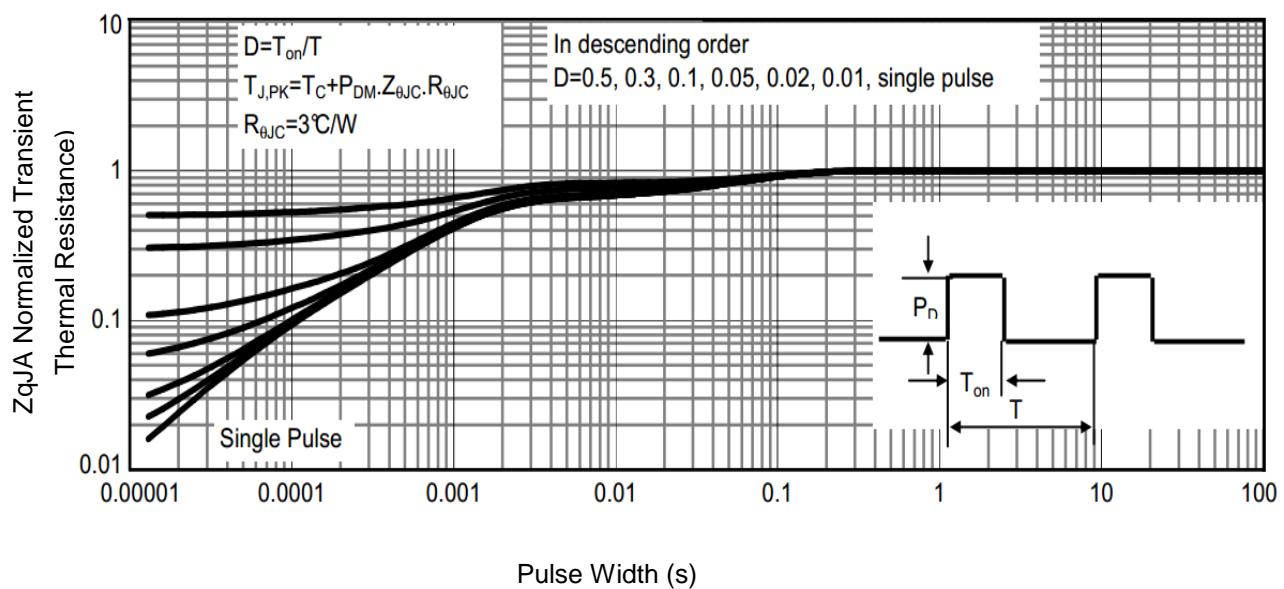


Fig 9 . Normalized Maximum Transient Thermal Impedance

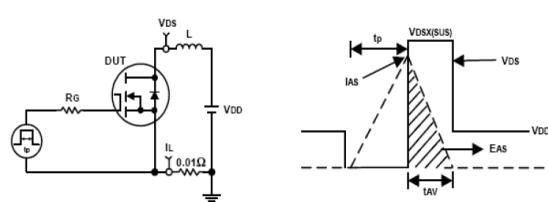


Fig 10. Unclamped Inductive Test Circuit and waveforms

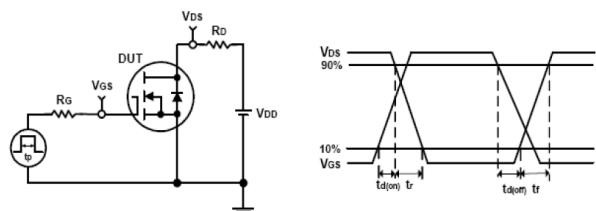
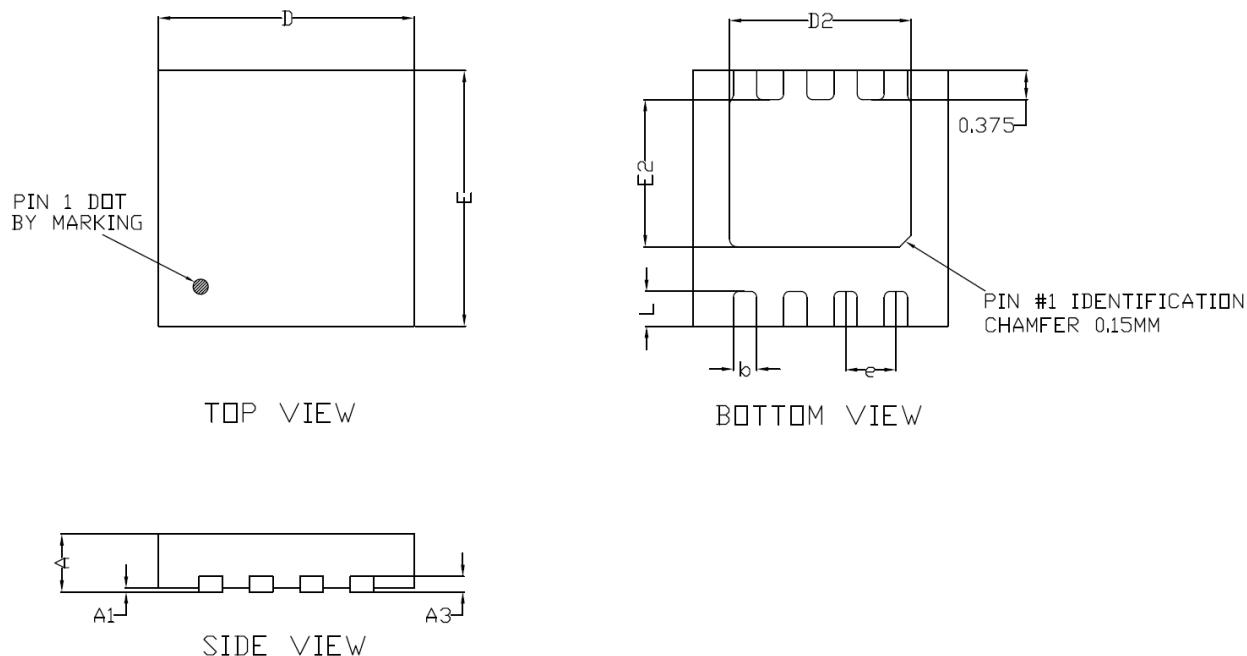


Fig 11. Switching Time Test Circuit and waveforms

TDFN3.3x3.3 Package Outline Data



Lead finish : NiPdAu

DIMENSIONS (unit : mm)

Symbol	Min	Typ	Max	Symbol	Min	Typ	Max
A	0.70	0.75	0.80	A1	0.00	--	0.05
A3	0.20 REF			D	3.25	3.30	3.35
E	3.25	3.30	3.35	D2	2.30	2.35	2.40
E2	1.85	1.90	1.95	b	0.25	0.30	0.35
L	0.35	0.45	0.55	e	0.65 BSC		

Customer Service

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